

# Series 219 SMD DIP Switch

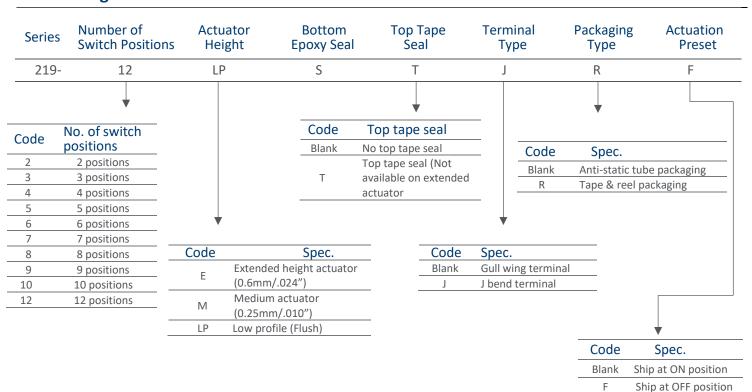
- Removable tape seal to withstand IR vapor phase or wave soldering temperatures, and board washing
- Gull-wing and "J"bend terminal configurations
- Available low profile, medium, and extended height actuators
- SPST configuration available
- 0.6mm/.024" actuator travel
- Optional top tape seal for board spray washing



## Description

Positive detent separated from contactor causes contactor does not deflect during actuation. Unique compact type design allows to be used at small size application. Optional top tape sealed structure is optimized for board washing during soldering process. It makes it the ideal choice for any server, security and HVAC systems.

#### **Ordering Information**



Notes: Contact CTS for other common features not listed.



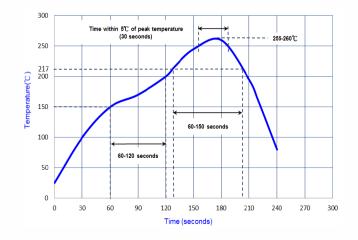
# **Electrical Specifications**

Parameter	Conditions & Remarks Min		Max	Unit
Circuit	SPST	2		position
Contact Resistance	Initial		25	milliohms
	At end of life	At end of life		
Insulation Resistance	Between insulated terminals		megohms	
Dielectric Strength	500 VAC between adjacent		1 minu	
	switches	1		minute
Actuation Life	100mA @ 20 VDC	2,000		cyclos
	0.1mA @ 5 VDC (dry circuit)			cycles
Switch Capacitance	Between adjacent closed	5		pF
	switches			
			100	mA
Nonswitching Rating			or	or
			50	VDC

## **Mechanical and Environmental**

Soldering	Maximum reflow temperature, 250°C for 30 seconds		
MSL	Level 1		
RoHS	Lead-Free. Fully compliant to RoHS Directive 2011/65/EU		
Shock	Per MIL-STD-202F, method 213B, condition A( 50G's)		
	with no contact inconsistencies greater than 1 microsecond		
Vibration	Per MIL-STD-202F, method 204D, condition B ( .06" or 15G's between 10 HZ to 2K HZ) with		
Vibration	no contact inconsistencies greater than 1 microsecond		
Coplanarity	0.1mm/.004" maximum		
Seal	Bottom epoxy seal standard		
	Top tape seal optional		
Marking	Special marking available-consult CTS		
Dockooing	Standard anti-static tube packaging		
Packaging:	Optional tape and reel packaging		
<b>Operating Temperature</b>	-55°C to +85°C		
Range	-55 C 10 +65 C		
Storage Temperature Range	-55°C to +85°C		

#### **Soldering Profile**

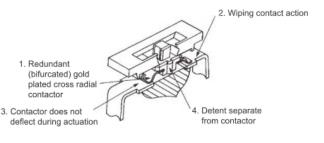




## **Mechanical Specifications**

#### CTS SERIES 219 SMT CONTACT FEATURES

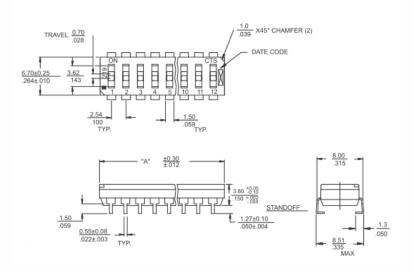
- Value of Redundant (Bifurcated) Gold Plated Contacts: Redundancy dramatically reduces the probability of contact failure while gold contact material provides the highest environmental protection, IMPROVING RELIABILITY.
- 2. Value of Wiping Contact Action: Clean contact area, IMPROVING RELIABILITY.
- Value of Contactor Not Deflecting During Actuation: Constant contact pressure eliminates overstressing contacts, IMPROVING RELIABILITY.
- Value of Detent Separate from Contactor: Separate detent allows optimization of nondeflecting contactor and detent designs, IMPROVING RELIABILITY.



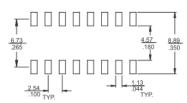
"A" Overall Dimension	No. of Switch positions	
6.55/.258	2	
9.09/.358	3	
11.63/.458	4	
14.17/.558	5	
16.71/.658	6	
19.25/.758	7	
21.79/.858	8	
24.33/.958	9	
26.87/1.058	10	
31.95/1.258	12	

Figure 1 – Surface Mount J Bend Terminal

#### "J" Bend Terminals Low Profile Actuator



#### "J" Bend Surface Mount Pad Layouts

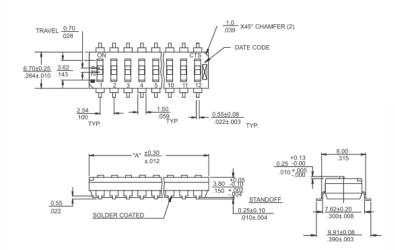


DIMENSION: mm

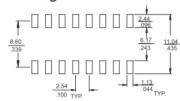


Figure 2 – Surface Mount Gull Wing Terminal

#### Gull Wing Terminals Medium Height Actuator



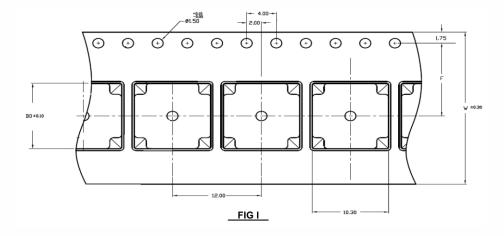
## **Gull Wing Surface Mount Pad Layouts**



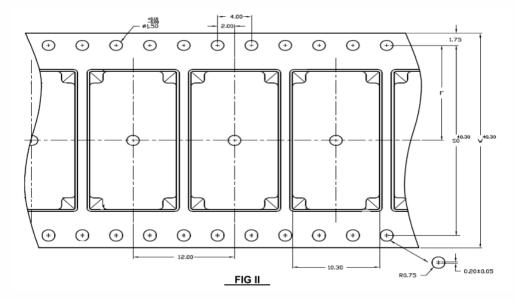
DIMENSION:  $\frac{mm}{inch}$ 

# **Packing: Tape and Reel**

					Onit: mm
SW Section	Fig	Во	W	F	SO
2	I	7.50	16.0	7.5	-
3	I	10.00	16.0	7.5	-
4	I	12.50	24.0	11.5	-
5	I	15.10	24.0	11.5	-
6	I	17.60	24.0	11.5	-
7	П	20.20	32.0	14.2	28.4
8	П	22.70	44.0	20.2	40.4
9	П	25.22	44.0	20.2	40.4
10	П	27.80	44.0	20.2	40.4
12	- II	32.90	44.0	20.2	40.4



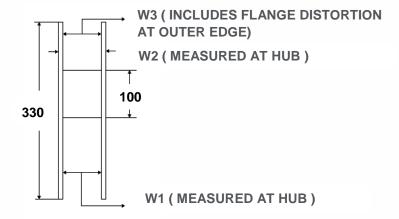




#### **SPECIFIED REEL PARTS DIMENSIONS:**

Unit: mm

SW Section	W1	W2	W3
2~3	16.4	22.4 MAX.	15.9 MIN./19.5 MAX.
4~6	24.4	30.4 MAX.	23.9 MIN./27.4 MAX.
7	32.4	38.4 MAX.	31.9 MIN./35.4 MAX.
8~12	44.4	50.4 MAX.	43.9 MIN./47.4 MAX.



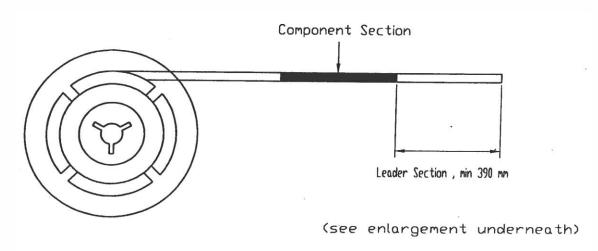


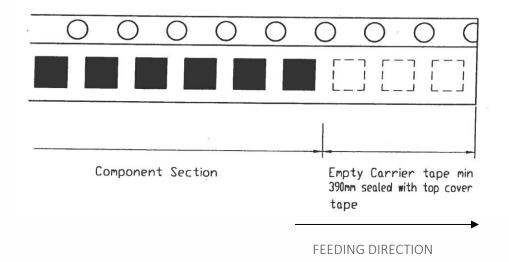
- 1. TAPE SPROCKET HOLE PITCH: 4.0 ± 0.1MM
- 2. ALL SMT ASSEMBLING MACHINES WILL PICK-UP THE COMPONENT FROM THE POINT, WHICH
- 3. IS LOCATED IN THE CENTRE OF TWO ADJACENT SPROCKET HOLES IN FEEDING DIRECTION. THIS MUST BE TAKEK INTO ACCOUNT WHEN DESIGNING THE LOCATION OF THE COMPONENT IN T&R POCKET.
- 4. RECOMMENDED PART ORIENTATION IN TAPE & REEL POCKET. ORIENT SWITCH TERMINAL #1 TO THE SIDE OF ROUND SPROCKET HOLES, SEE PICTURE BELOW.



#### LENGTH OF TAPE

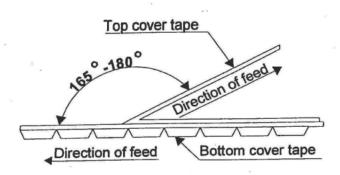
5. THERE SHALL BE A LEADER OF 390mm MINIMUM WHICH IS SEALED ONTO EMPTY CARRIER TAPE, SEE PICTURE BELOW.







- TAPE BREAK FORCE, PEEL STRENGTH AND ANGLE.
  REQUIRED SETTINGS:
  - TOP COVER TAPE PEEL FORCE: 10 ~ 130 gm
  - ANGLE BETWEEN THE TOP COVER TAPE AND THE DIRECTION OF FEED DURING PEEL OFF: 165°~ 180°



**Embossed Carrier Tape**